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**TEHCET**

Electronics Materials Information

**2024-2025**

**SEMICONDUCTOR MATERIALS MARKETS**

**EXECUTIVE EDITION™**

**CMP CONSUMABLES SLURRY  
& PADS MARKETS & TRENDS**

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TEHCET CA LLC

# SCOPE

## **Scope**

- This report provides an executive overview of the market landscape and supply-chain for CMP Pads and Slurry used in semiconductor device fabrication. It includes concise information about key suppliers, issues/trends in the material supply chain, estimates on supplier share ranking, and forecasts for the material segments.
- This Executive Edition™ report provides focused information for:
  - Business Development Managers;
  - Supply Chain Managers;
  - R&D directors;
  - Investors / Financial Analysts; and
  - Policy Makers.

## **Methodology**

- TECHCET employs subject matter experts having first-hand experience within the industries which they analyze. Most of TECHCET's analysts have over 25 years of direct and relevant experience in their field. Our analysts survey the commercial and technical staff of IC manufacturers and their suppliers and conduct extensive research of literature and commerce statistics to ascertain the current and future market environment and global supply risks. Combining this data with TECHCET's proprietary, quantitative wafer forecast results in a viable long-term market forecast for a variety of process materials.
- Data and analysis is generated from both primary and secondary market research performed by TECHCET's staff of market and technology analysts. Forecasts models are developed from TECHCET's database of historical information, process flows and wafer forecasts by technology node and device type. These are then validated with market research interviews with industry experts. For more information on TECHCET Critical materials Reports™ please go to <https://TECHCET.com>

## **Reader's Note**

- This report represents the analysis and interpretation of information generally available to the public or released by responsible agencies or individuals. Data was obtained from sources considered reliable. However, accuracy or completeness is not guaranteed.

## ANALYST BIOGRAPHY

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**Karey Holland, Ph.D.**  
*Chief Strategist and  
Co-Founder of TECHCET*

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